

Title (en)

Inductive component and method of manufacturing same

Title (de)

Induktives Bauelement und Verfahren zu dessen Herstellung

Title (fr)

Composant inductif et son procédé de fabrication

Publication

**EP 0907190 A3 20000712 (DE)**

Application

**EP 98116940 A 19980905**

Priority

DE 19742928 A 19970929

Abstract (en)

[origin: EP0907190A2] The windings former, is melted onto the ferromagnetic core (1), through an excess of plastic, and/or the core is fastened to the substrate (2) by melting-on plastic. An Independent claim is included for the method of construction. After placing core, former and winding on the substrate, the flanges projecting over the core are heated, to melt the plastic locally. The softened plastic is pressed onto the surfaces of the core, and allowed to set. Preferably the excess plastic is melted-on by a heated rod. Preferred features: The core is fastened to the thermoplastic substrate by melting-on the plastic flanges (4). There is a projection (5) on the edge of each flange. The projection extends over part of the flange length. The flange is introduced into openings or separate slots of the core.

IPC 1-7

**H01F 27/26; H01F 41/00**

IPC 8 full level

**H01F 27/30** (2006.01); **H01F 27/06** (2006.01); **H01F 27/26** (2006.01); **H01F 27/32** (2006.01); **H01F 30/00** (2006.01); **H01F 41/00** (2006.01)

CPC (source: EP)

**H01F 27/266** (2013.01); **H01F 41/005** (2013.01)

Citation (search report)

- [X] DE 3040334 A1 19820527 - DRALORIC ELECTRONIC [DE]
- [A] EP 0315527 A1 19890510 - OREGA ELECTRO MECANIQUE [FR]
- [A] DE 9010132 U1 19900906
- [A] EP 0509936 A2 19921021 - MERLIN GERIN [FR]

Cited by

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Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE

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**EP 0907190 A2 19990407; EP 0907190 A3 20000712; EP 0907190 B1 20020619;** AT E219601 T1 20020715; DE 59804488 D1 20020725;  
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JP 27134398 A 19980925; PT 98116940 T 19980905